

1 March 2021



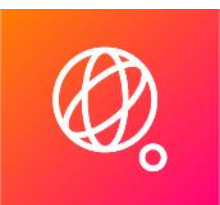
PICs for quantum communication the UNI QORN perspective

Joint Quantum Flagship & Photonics21 Focus Group

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UNIQORN

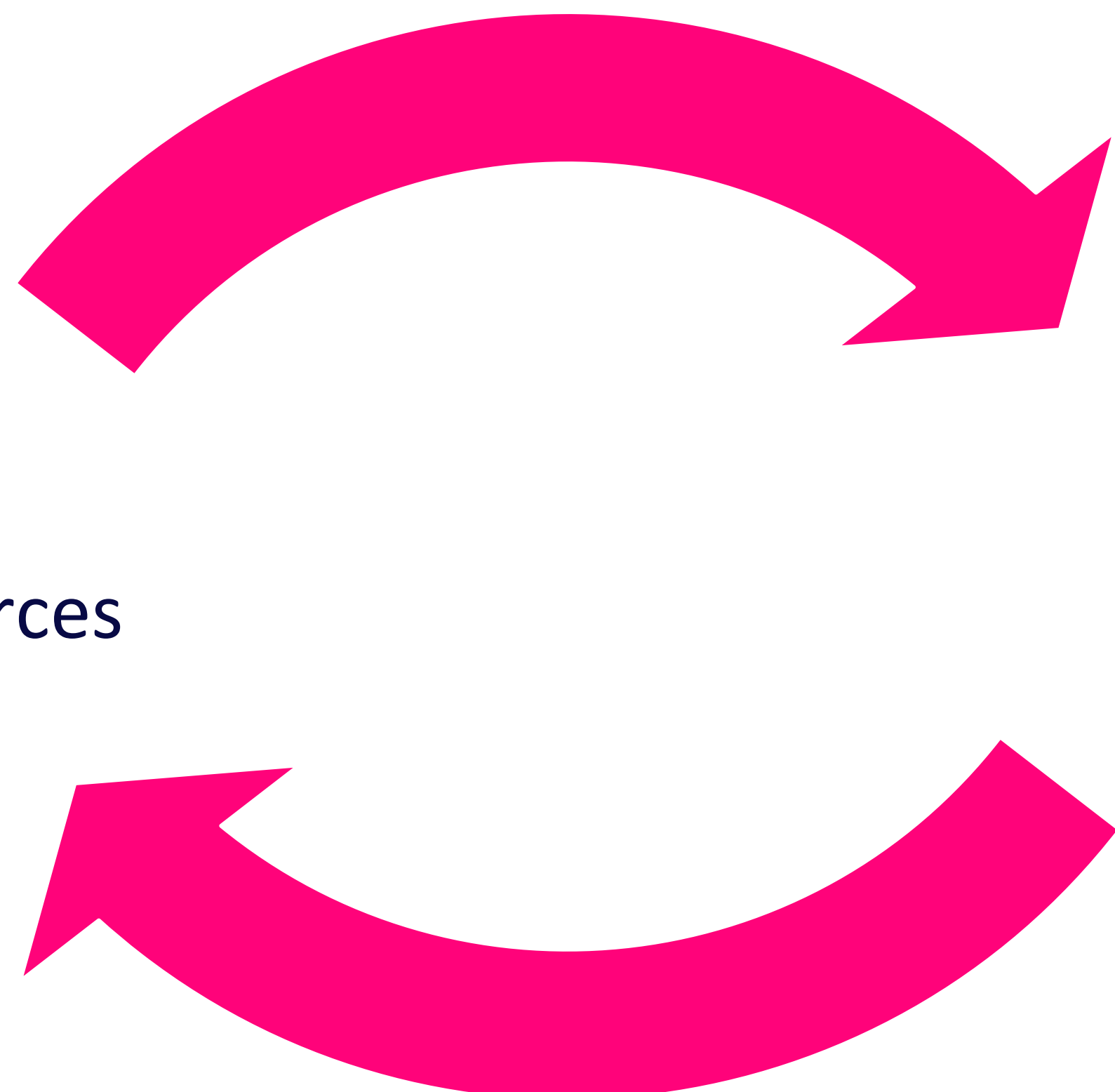
a very brief overview



Quantum Eco-System from

Fabrication

- Photonic integration
 - DV QKD
 - CV QKD
 - Non-classical light sources
- Enabling technology



Applications

- QKD (coexistence and network routing)
- One-time programs
- Oblivious transfer
- QRNG integration on commercial network devices (NIC)
- Privacy preserving data base access

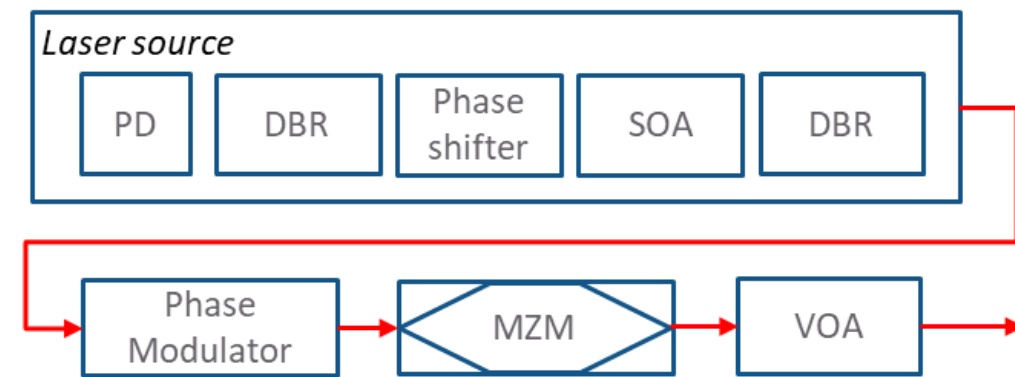
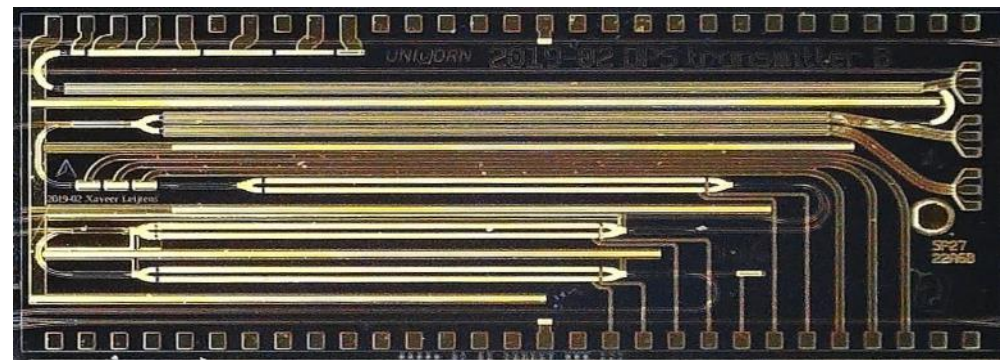


Monolithic QPICs

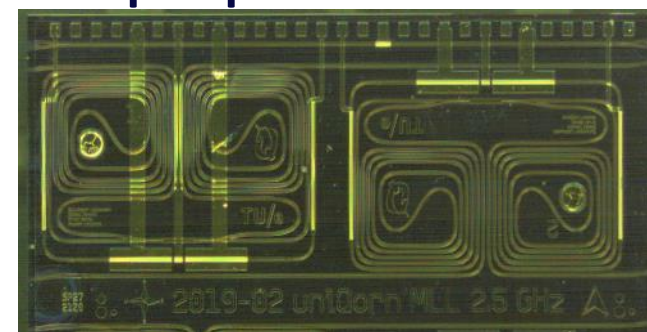
InP QPIC



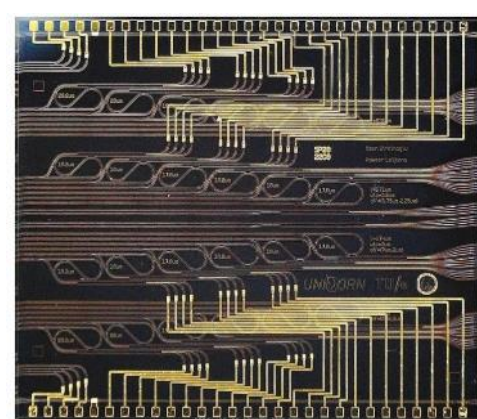
- QKD transmitter chip (DV and CV)
 - Laser
 - Modulators (Phase, amplitude, I/Q)
 - Passive elements (couplers, variable optical attenuators)



- Mode-locked laser
 - 1550nm, 2.5 GHz rep. rate, 15 ps pulse width

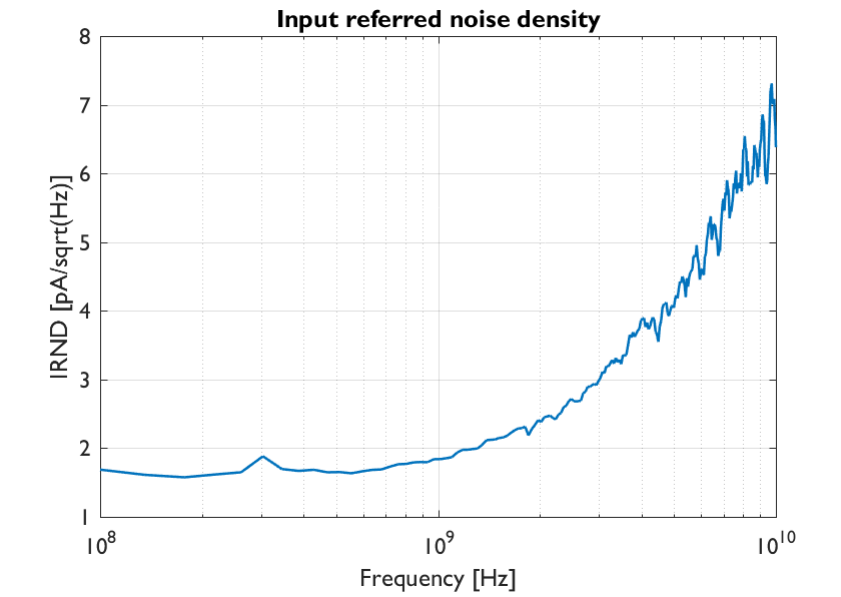
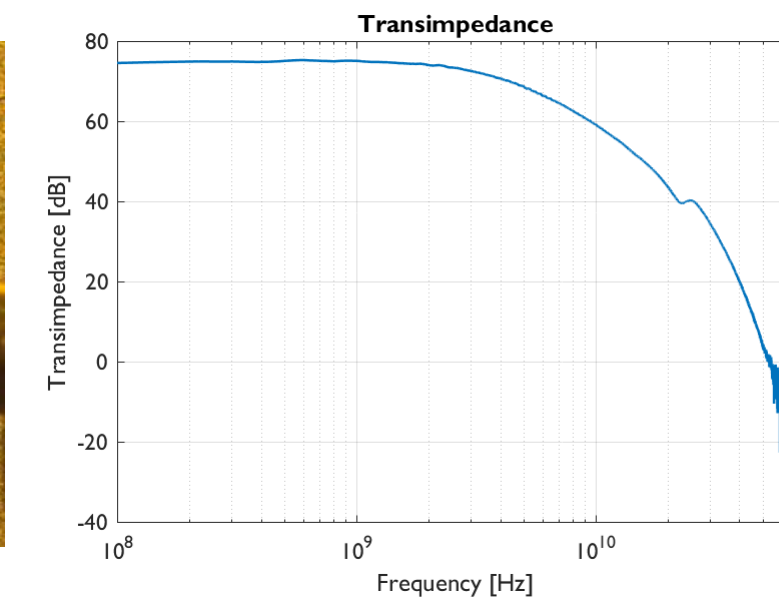
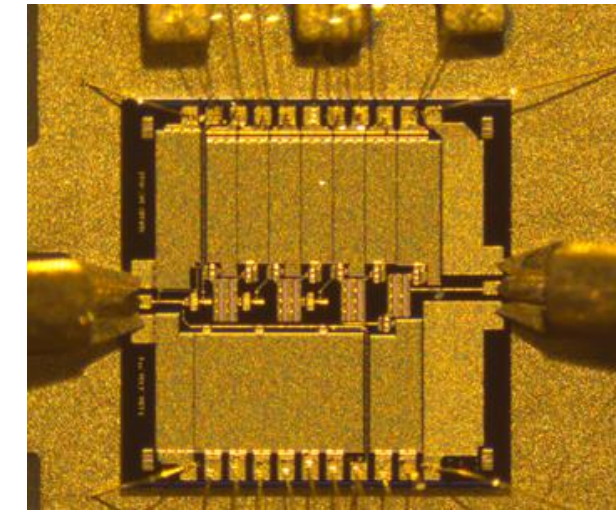


- Balanced photo detector
 - LO: 60 kHz, 30 nm tuning

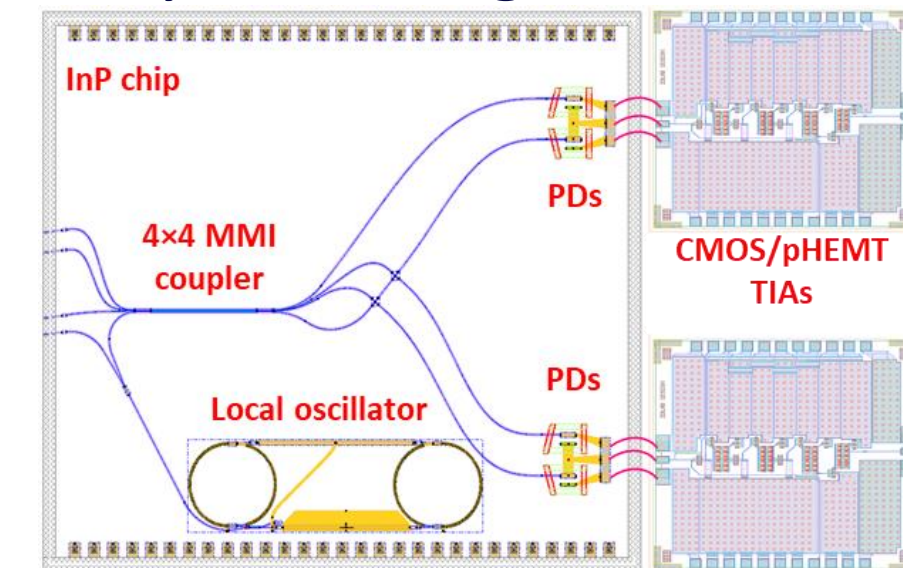


CMOS PICs

- pHEMT Trans impedance amplifier (CV quantum information processing)

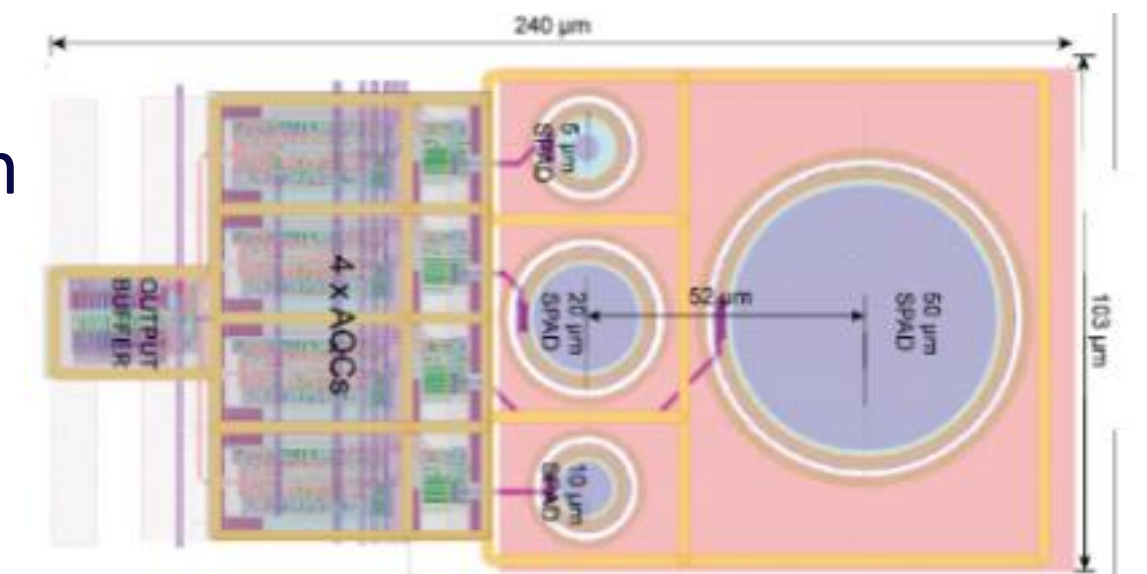


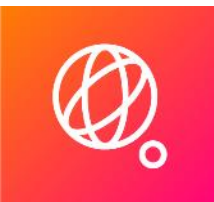
- Bandwidth: 1 GHz; Noise: < 2.5 pA/sqrt (Hz), >22 dB clearance
- CV receiver based on hybrid integration of balanced detector and TIA



CMOS detector PIC

- 32 x 1 Si-SPAD array
- Room temp operation
- 65% @ 500nm; 12% @ 800nm
- On board coincidence logic
- Variable SPAD size





Hybrid QPICs

• Polymer platform “PolyBoard”



- Integration of micro optics
 - Passive elements (lenses, mirrors, filters, polarisation handling, etc.)
 - Active elements (switches)
- Integration of nonlinear optical elements (ppLN, ppKTP, AlGaAs)
- Hybrid assembly of PolyBoard and Si-APD array

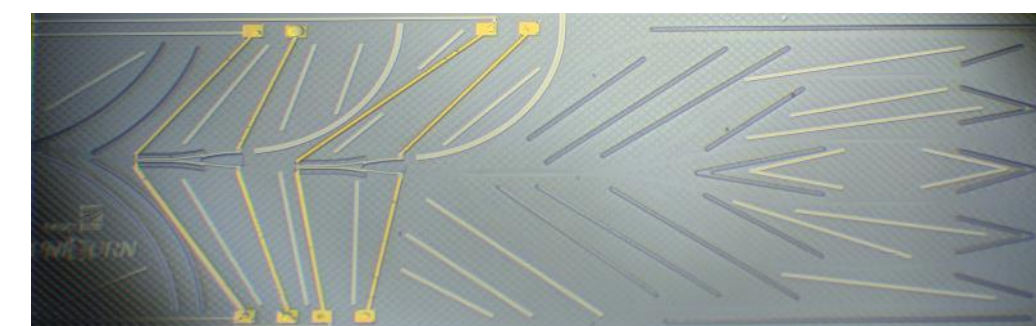


• PolyBoard modules

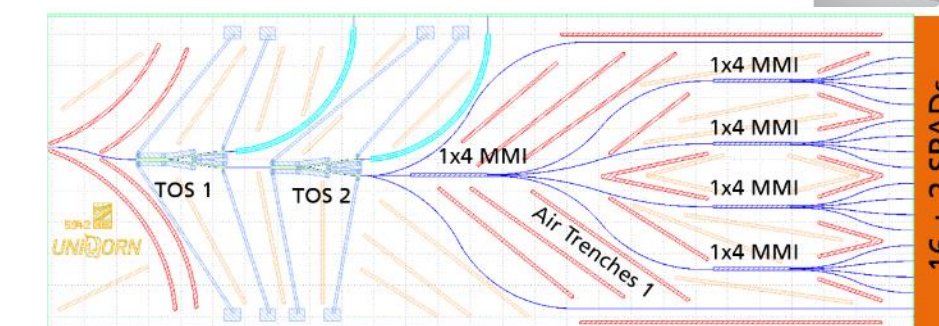
- Quantum Random Number Generator
- Heralded single-photon source (waveguide ppLN)
- Entangled photons sources (polarization and time-bin)
- Squeezed light sources
- Add-on modules
 - Reconfigurable add-drop multiplexer
 - Polarization analyser
 - Phase tuneable aMZI
 - Wavelength converter



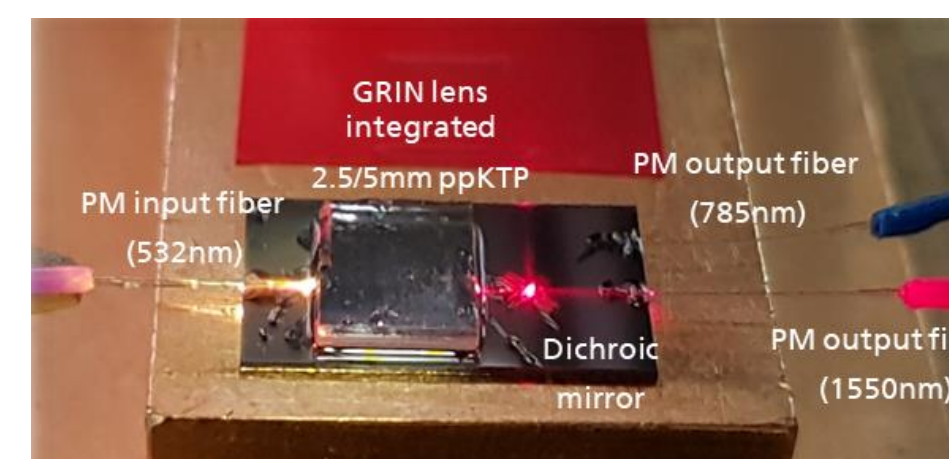
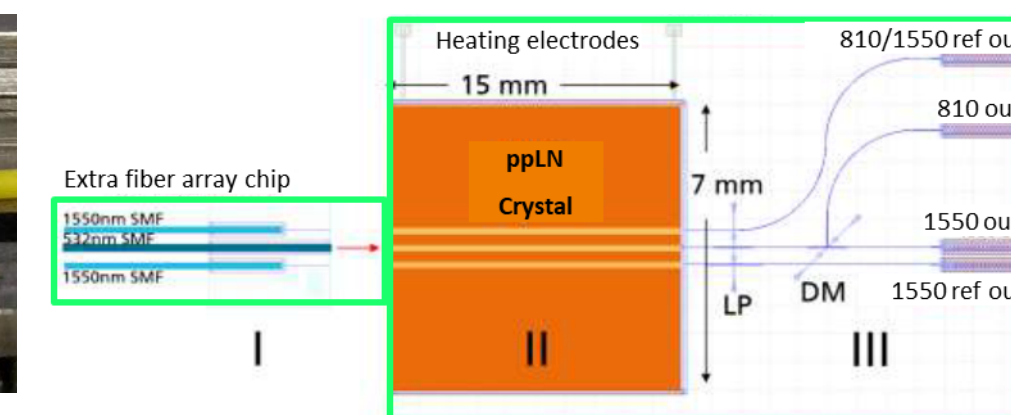
Switchable add/drop WDM



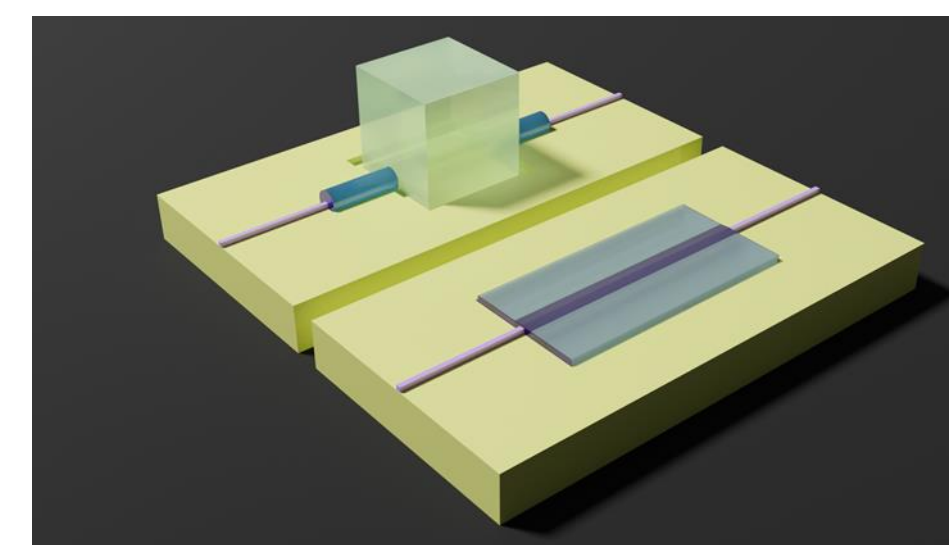
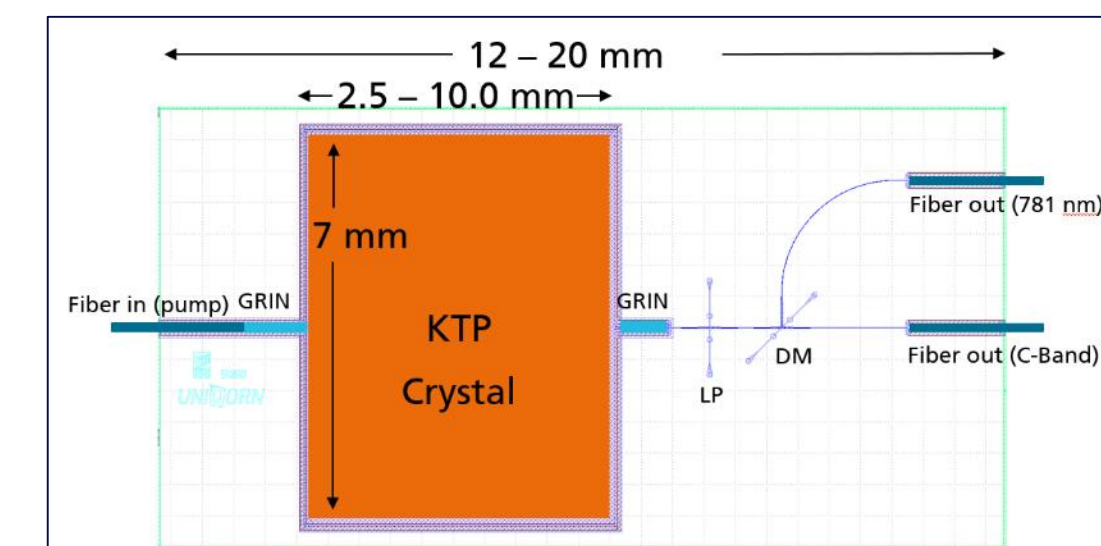
QRNG chip



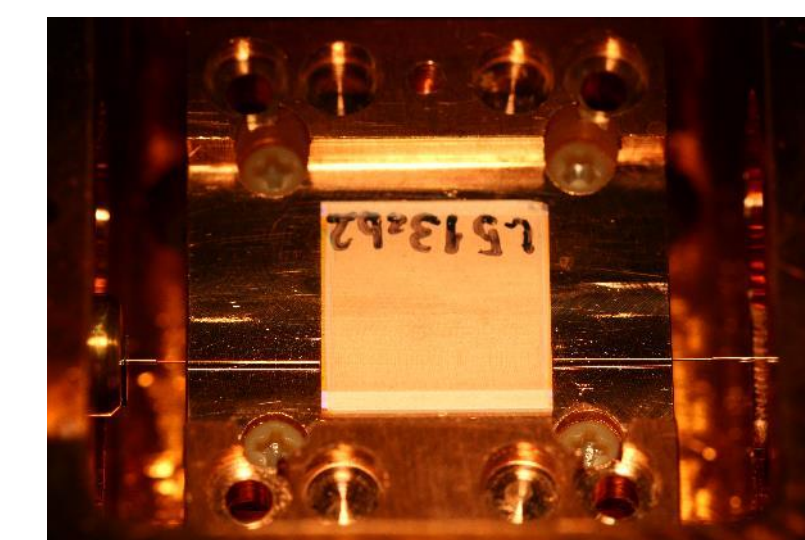
Heralded photon source



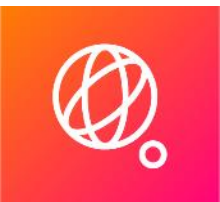
Polarisation entangled photon source



Squeezed light source based on bulk ppKTP and waveguide ppLN

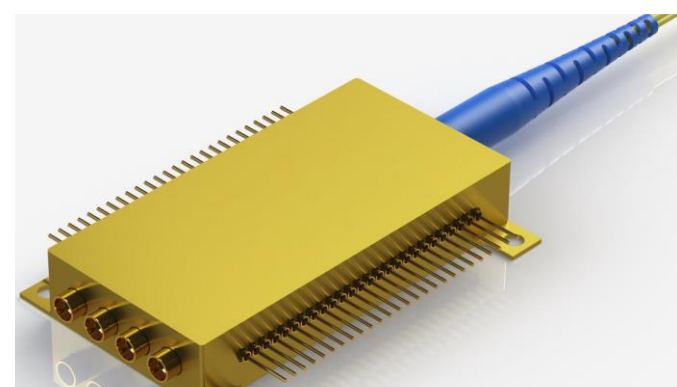


Squeezed light on waveguide ppLN

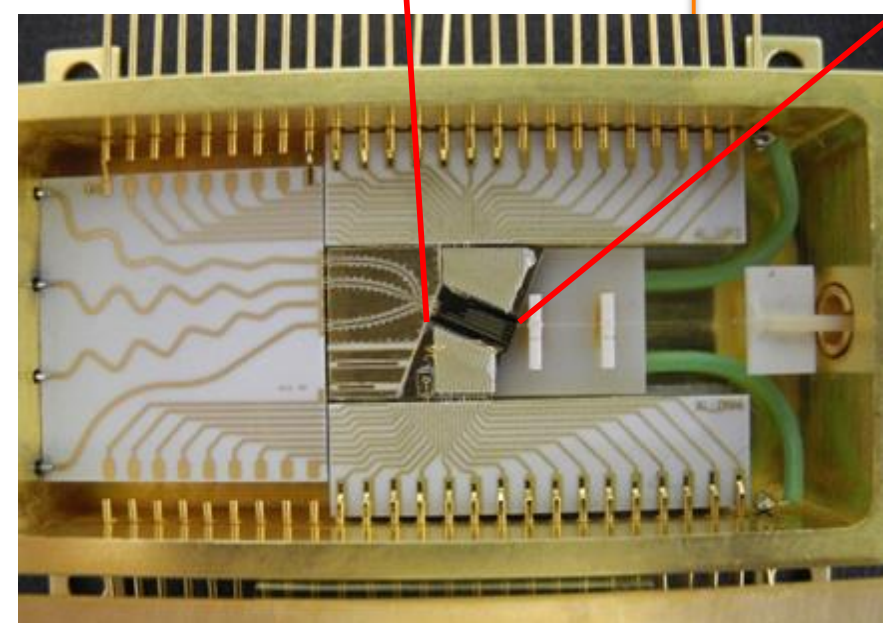
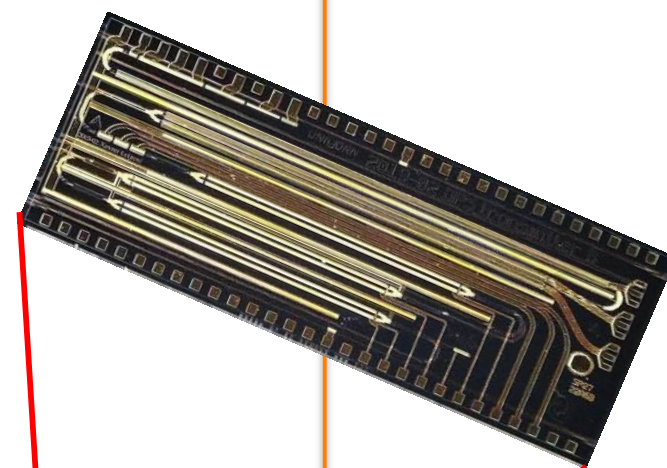


QPIC Packaging

• Transmitter chip



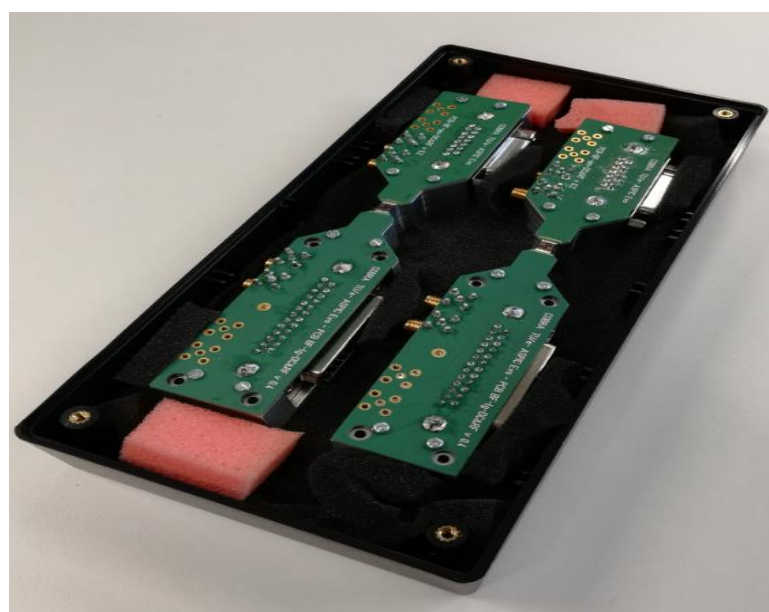
- 4 RF lanes
- SMF output fiber
- DC ports for laser control, bias controls and and attenuation
- TEC cooling



• Mode-locked laser



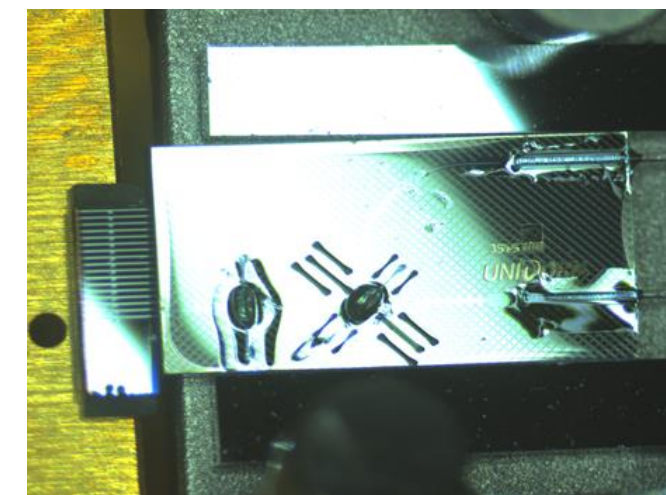
- Mounted and wire bonded
- SMF output fiber



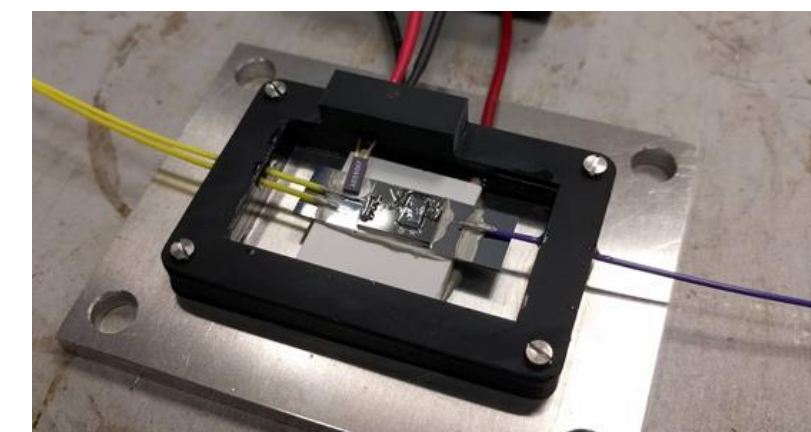
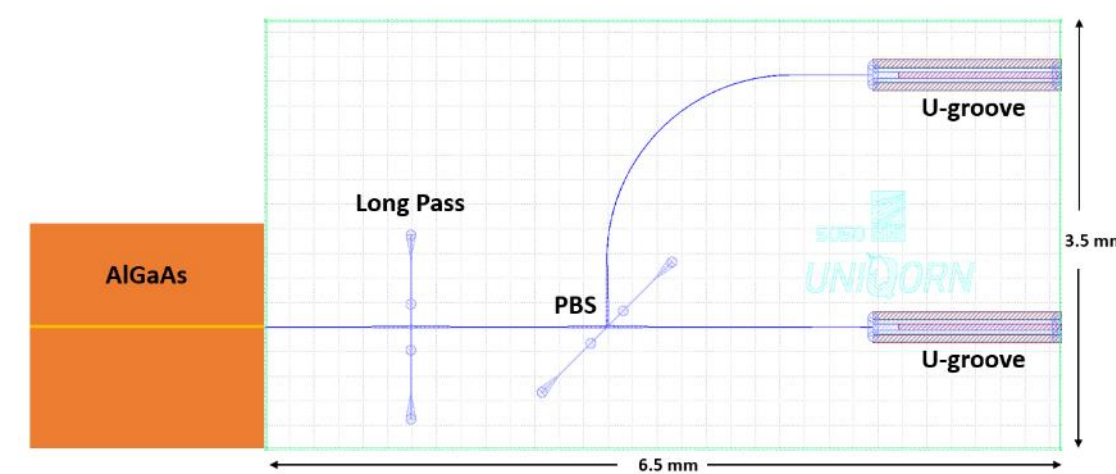
• PolyBoard packaging



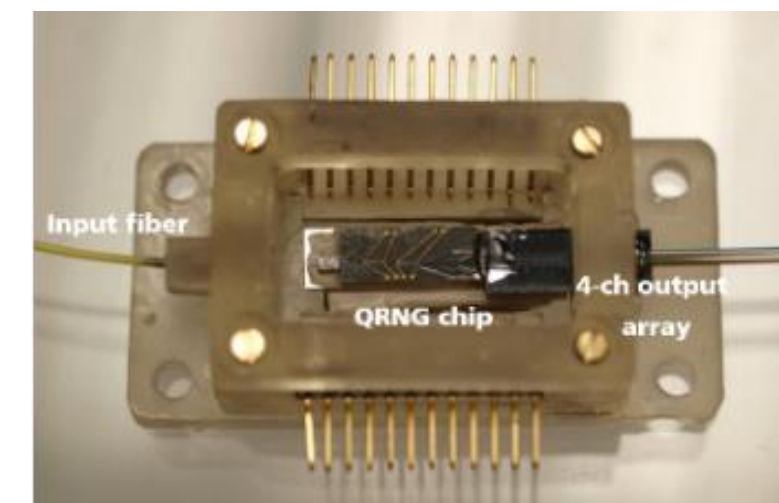
- Bonding of optical in/output fibers
- TEC cooler
- Off-chip components



Coupling of AlGaAs and PolyBoard (assembly photo)



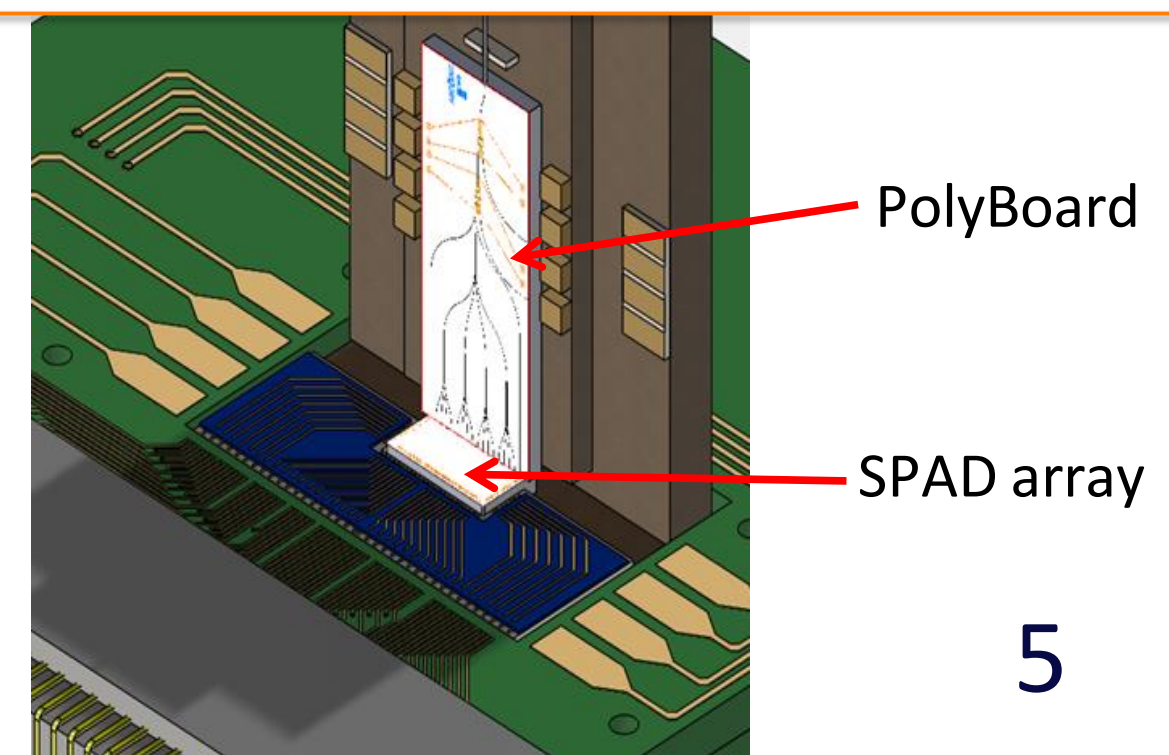
Packaged pol. entangled source

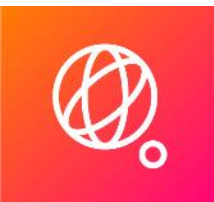


Packaged QRNG

• SPAD – PolyBoard Hybrid Integration

- Bonding of optical in/output fibers





Lessons learned

so far...

- No universal platform for all functions
- Move to hybrid manufacturing, but requires delicate assembly procedure
- Detailed specifications necessary for production process
- Performance reproducibility
- Quantum communication devices extremely loss sensitive
 - Needs to be addressed during production and packaging
- Long turn around times, especially for MPW
- Packaging and co-integration needs to be addressed
 - Bare die vs. packaged system characterisation

The **UNIQUORN** team:



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Thank you very much for your attention!